

Surface Mount Ultra Fast Recovery Rectifiers

Features:

- *For Surface Mount Application
- *Glass Passivated Chip
- *Low Reverse Leakage Current
- *Low Forward Voltage Drop And High Current Capability
- *Plastic Material Has UL Flammability Classification 94V-0

Mechanical Data:

- * Case: Molded Plastic, MINI-SMA(Similar to SOD-123F)
- * Terminals: Solder Plated, Solderable per ML-STD-750 Method 2026
- * Polarity: Indicated by Cathode Band
- * Weight: 0.040 grams

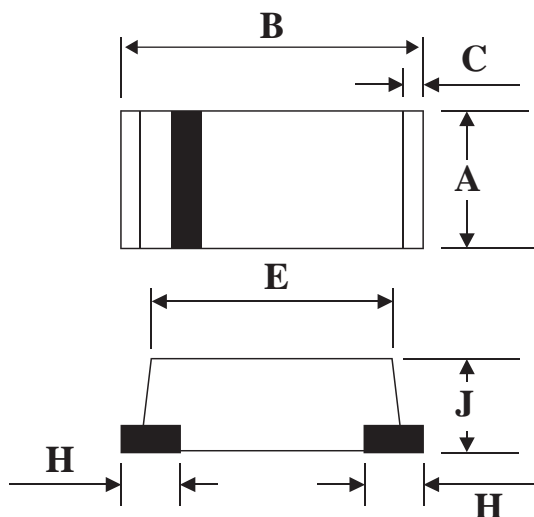
**REVERSE VOLTAGE
50 TO 1000 VOLTS
FORWARD CURRENT
1.0 AMPERE**



**MINI-SMA
(SOD-123F)**

MINI-SMA Outline Dimension

unit:mm



MINI-SMA

Dim	Min	Max
A	1.40	1.80
B	3.70	4.10
C	-	0.30(TYP)
E	2.80	3.20
H	-	0.90(TYP)
J	1.40	1.60

Maximum Ratings and Electrical Characteristics

Rating 25°C Ambient Temperature Unless Otherwise Specified.
Single Phase Half Wave, 60Hz , Resistive or Inductive Load.
For Capacitive Load, Derate Current by 20%.

Characteristics	Symbol	HFM101M	HFM102M	HFM103M	HFM104M	HFM105M	HFM106M	HFM107M	Unit
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	V _{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current @T _A =50°C	I _{F(AV)}	1.0							A
Peak Forward Surge Current, 8.3 ms Single Half Sine-Wave Superimposed on Rated Load (JEDEC Method)	I _{FSM}	30							A
Maximum Instantaneous At 1.0A DC	V _F	1.0		1.3		1.7		V	
Maximum DC Reverse Current @T _A =25°C At Rated DC Blocking Voltage @T _A =100°C	I _R	5.0 150							uA
Maximum Reverse Recovery Time	T _{RR}	50				75			ns
Typical Junction Capacitance (Note 1)	C _J	20(TYP)							Pf
Typical Thermal Resistance (Note 2)	R _{θJA}	42(TYP)							°C/W
Operating Temperature Range	T _J	-55 to+150							°C
Storage Temperature Range	T _{STG}	-55 to+150							°C

NOTES: 1.Measured at 1.0MHz applied reverse voltage of 4.0V DC.

2.Thermal Resistance Junction to Ambient.

Device Marking

Item	Marking	Item	Marking
HFM101M	H1	HFM105M	H5
HFM102M	H2	HFM106M	H6
HFM103M	H3	HFM107M	H7
HFM104M	H4		

RATING AND CHARACTERISTIC CURVES

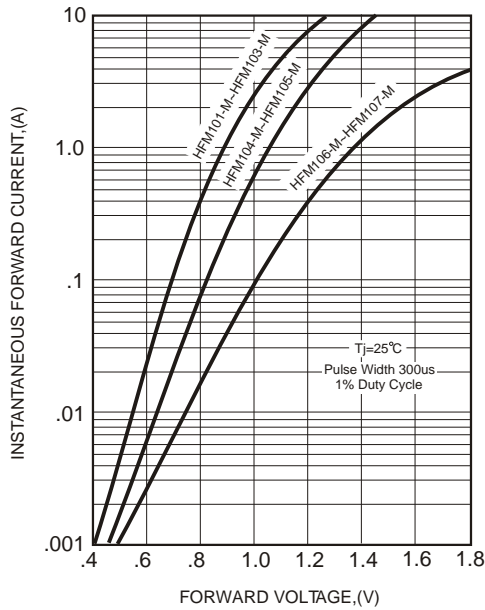
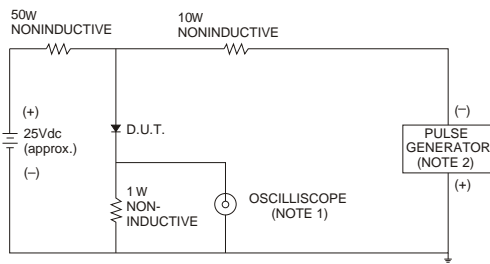


FIG.1-Typical Forward Characteristics



NOTES: 1. Rise Time= 7ns max., Input Impedance= 1 megohm.22pF.
2. Rise Time= 10ns max., Source Impedance= 50 ohms.

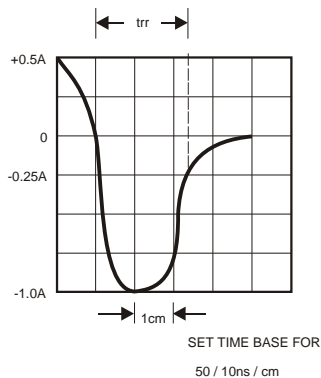


FIG.3- Test Circuit Diagram and Reverse Recovery Time Characteristics

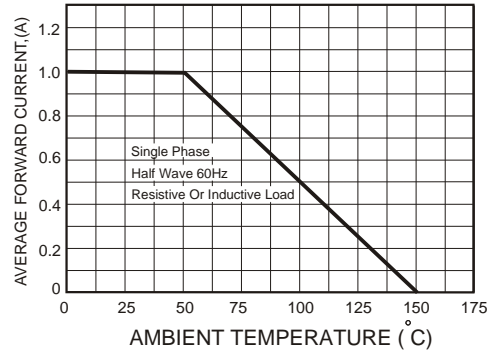


FIG.2-Typical Forward Current Derating Curve

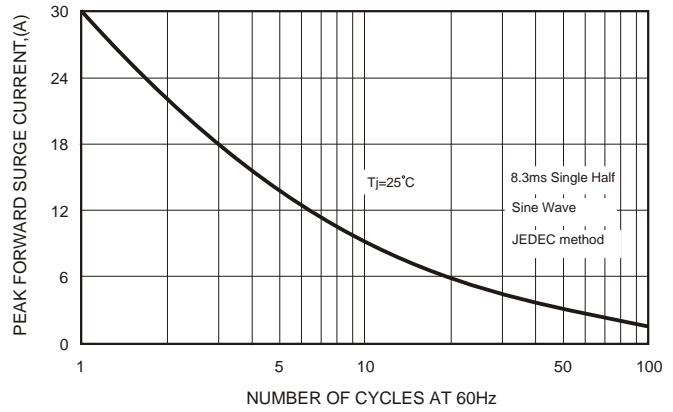


FIG.4-Maximum Non-repetitive Forward Surge Current

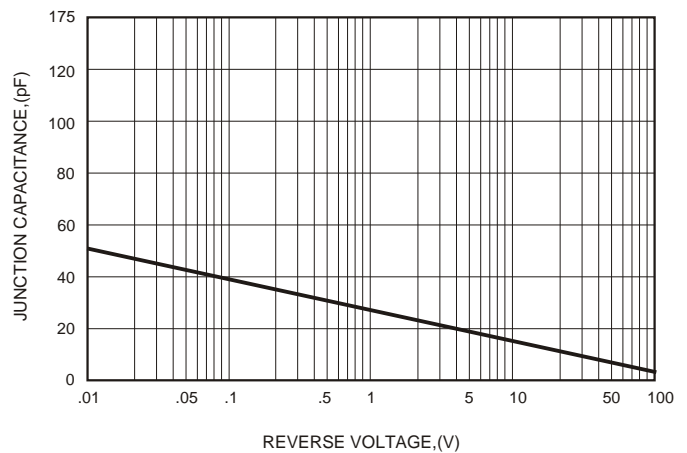


FIG.5-Typical Junction Capacitance